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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Obsolete
Number of LABs/CLBs	10000
Number of Logic Elements/Cells	40000
Total RAM Bits	4075520
Number of I/O	562
Number of Gates	-
Voltage - Supply	0.95V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 105°C (TJ)
Package / Case	1020-BBGA, FCBGA
Supplier Device Package	1020-OFcBGA Rev 2 (33x33)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfscm3ga40ep1-5ffan1020i

Figure 2-13. DLL to PLL

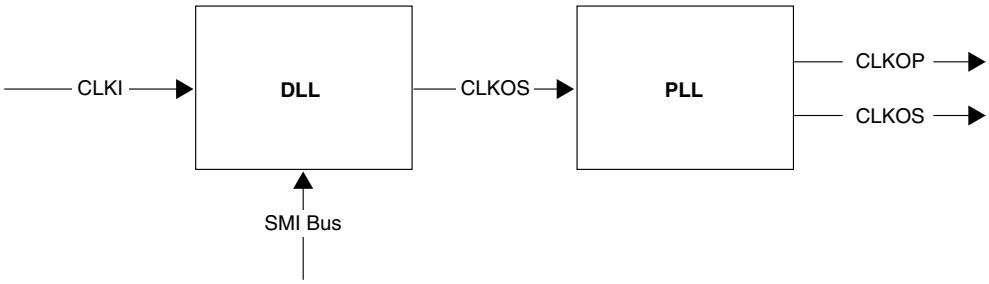


Figure 2-14 shows a shift of only CLKOP out in time.

Figure 2-14. PLL to DLL

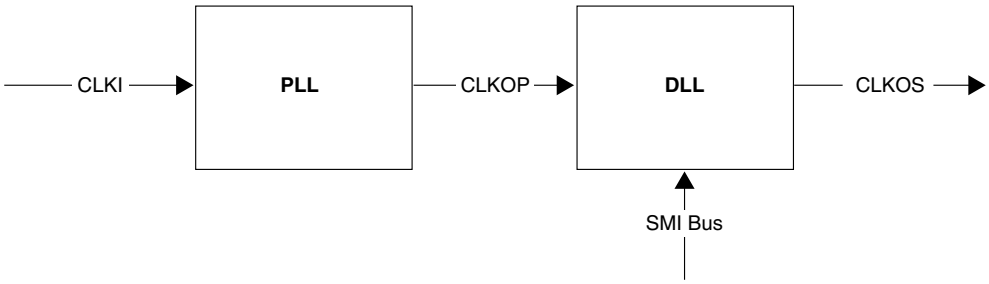
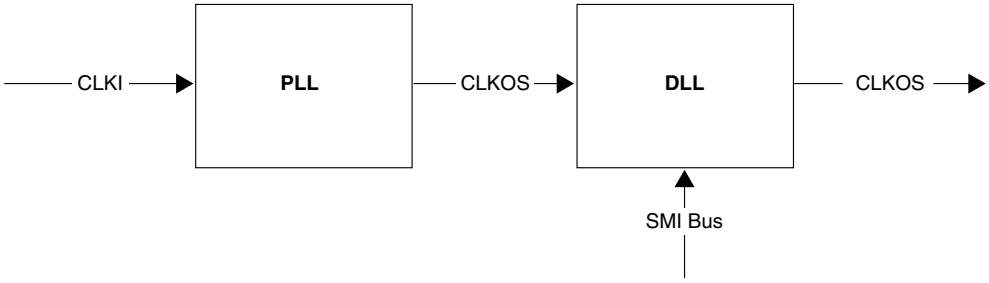


Figure 2-15 shows a shift of only CLKOS out in time.

Figure 2-15. PLL to DLL



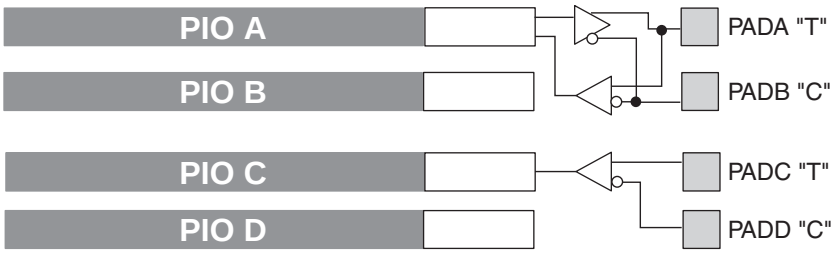
For further information on the DLL, please see details of additional technical documentation at the end of this data sheet.

sysMEM Memory Block

The sysMEM block can implement single port, true dual port, pseudo dual port or FIFO memories. Dedicated FIFO support logic allows the LatticeSC devices to efficiently implement FIFOs without consuming LUTs or routing resources for flag generation. Each block can be used in a variety of depths and widths as shown in Table 2-5. Memory with ranges from x1 to x18 in all modes: single port, pseudo-dual port and FIFO also providing x36.

high-speed interfaces in the LatticeSC devices. Figure 2-18 shows how differential receivers and drivers are arranged between PIOs.

Figure 2-18. Differential Drivers and Receivers



*Differential Driver only available on right and left of the device.

PIO

The PIO contains five blocks: an input register block, output register block, tristate register block, update block, and a control logic block. These blocks contain registers for both single data rate (SDR), double data rate (DDR), and shift register operation along with the necessary clock and selection logic.

Input Register Block

The input register block contains delay elements and registers that can be used to condition signals before they are passed to the device core. Figure 2-20 show the diagram of the input register block. The signal from the PURESPEED I/O buffer (DI) enters the input register block and can be used for three purposes, as a source for the combinatorial (INDD) and clock outputs (INCK), the input into the SDR register/latch block and the input to the delay block. The output of the delay block can be used as combinatorial (INDD) and clock (INCK) outputs, an input to the DDR/Shift Register Block or an input into the SDR register block.

Input SDR Register/Latch Block

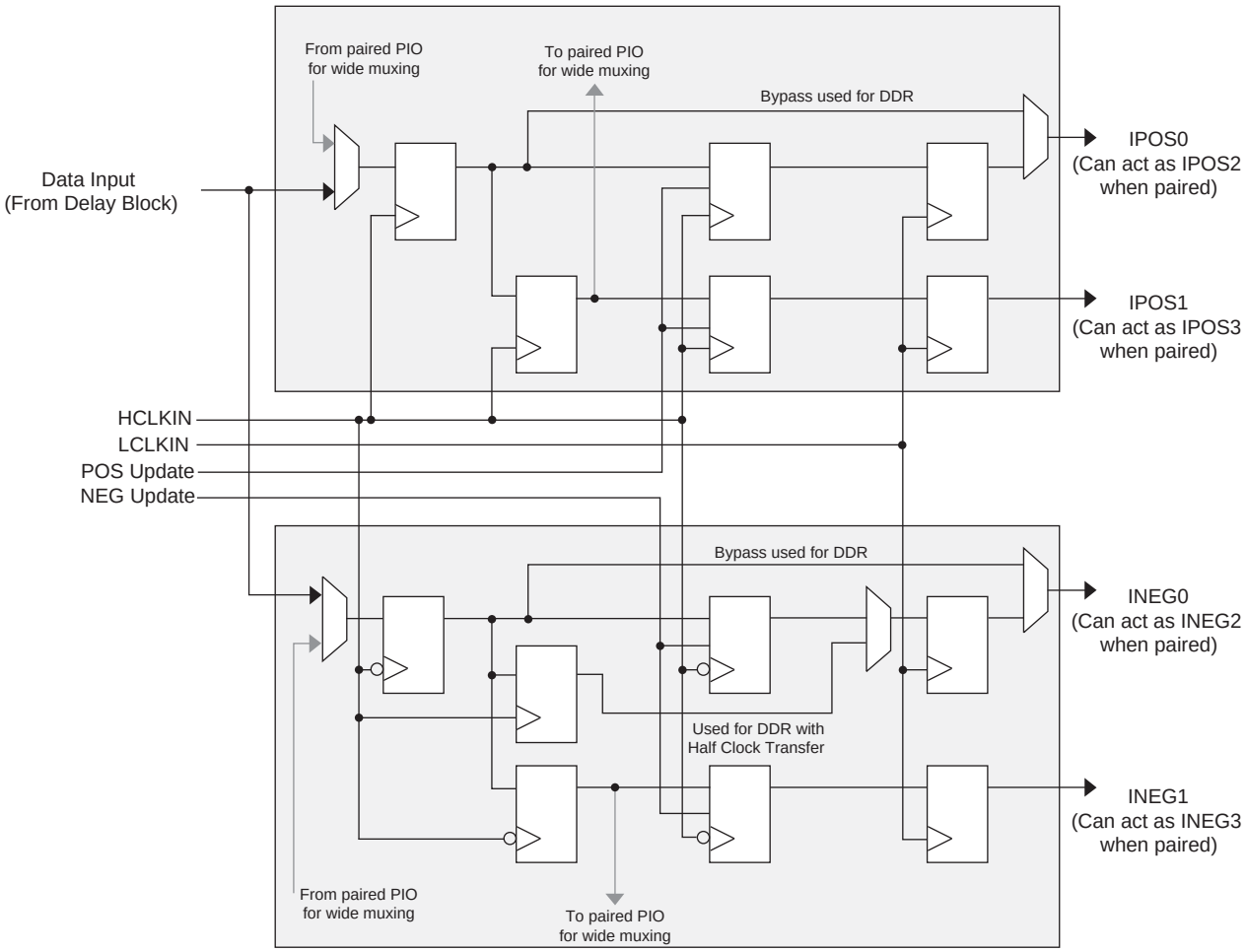
The SDR register/latch block has a latch and a register/latch that can be used in a variety of combinations to provide a registered or latched output (INFF). The latch operates off high-speed input clocks and latches data on the positive going edge. The register/latch operates off the low-speed input clock and registers/latches data on the positive going edge. Both the latch and the register/latch have a clock enable input that is driven by the input clock enable. In addition both have a variety of programmable options for set/reset including, set or reset, asynchronous or synchronous Local Set Reset LSR (LSR has precedence over CE) and Global Set Reset GSR enable or disable. The register and latch LSR inputs are driven from LSRI, which is generated from the PIO control MUX. The GSR inputs are driven from the GSR output of the PIO control MUX, which allows the global set-reset to be disabled on a PIO basis.

Input Delay Block

The delay block uses 144 tapped delay lines to obtain coarse and fine delay resolution. These delays can be adjusted during configuration or automatically via DLL or AIL blocks. The Adaptive Input Logic (AIL) uses this delay block to adjust automatically the delay in the data path to ensure that it has sufficient setup and hold time.

The delay line in this block matches the delay line that is used in the 12 on-chip DLLs. The delay line can be set via configuration bits or driven from a calibration bus that allows the setting to be controlled either from one of the on-chip DLLs or user logic. Controlling the delay from one of the on-chip DLLs allow the delay to be calibrated to the DLL clock and hence compensated for the variations in process, voltage and temperature.

Figure 2-21. Input DDR/Shift Register Block



Output Register Block

The output register block provides the ability to register signals from the core of the device before they are passed to the PURESPEED I/O buffers. The block contains a register for SDR operation and a group of registers for DDR and shift register operation. The output signal (DO) can be derived directly from one of the inputs (bypass mode), the SDR register or the DDR/shift register block. Figure 2-22 shows the diagram of the Output Register Block.

Output SDR Register/Latch Block

The SDR register operates on the positive edge of the high-speed clock. It has clock enable that is driven by the clock enable output signal generated by the control MUX. In addition it has a variety of programmable options for set/reset including, set or reset, asynchronous or synchronous Local Set Reset LSR (LSR has precedence over CE) and Global Set Reset GSR enable or disable. The register LSR input is driven from LSRO, which is generated from the PIO control MUX. The GSR inputs is driven from the GSR output of the PIO control MUX, which allows the global set-reset to be disabled on a PIO basis.

Output DDR/Shift Block

The DDR/Shift block contains registers and associated logic that support DDR and shift register functions using the high-speed clock and the associated transfer from the low-speed clock domain. It functions as a gearbox allowing low-speed parallel data from the FPGA fabric be output as a higher speed serial stream. Each PIO supports DDR and x2 shift functions. If desired PIOs A and B or C and D can be combined to form x4 shift functions. Figure 2-22 shows a simplified block diagram of the shift register block.

Tristate Register Block

The tristate register block provides the ability to register tri-state control signals from the core of the device before they are passed to the PURESPEED I/O buffers. The block contains a register for SDR operation and a group of three registers for DDR and shift register operation. The output signal tri-state control signal (TO) can be derived directly from one of the inputs (bypass mode), the SDR shift register, the DDR registers or the data associated with the buffer (for open drain emulation). Figure 2-24 shows the diagram of the Tristate Register Block.

Tristate SDR Register/Latch Block

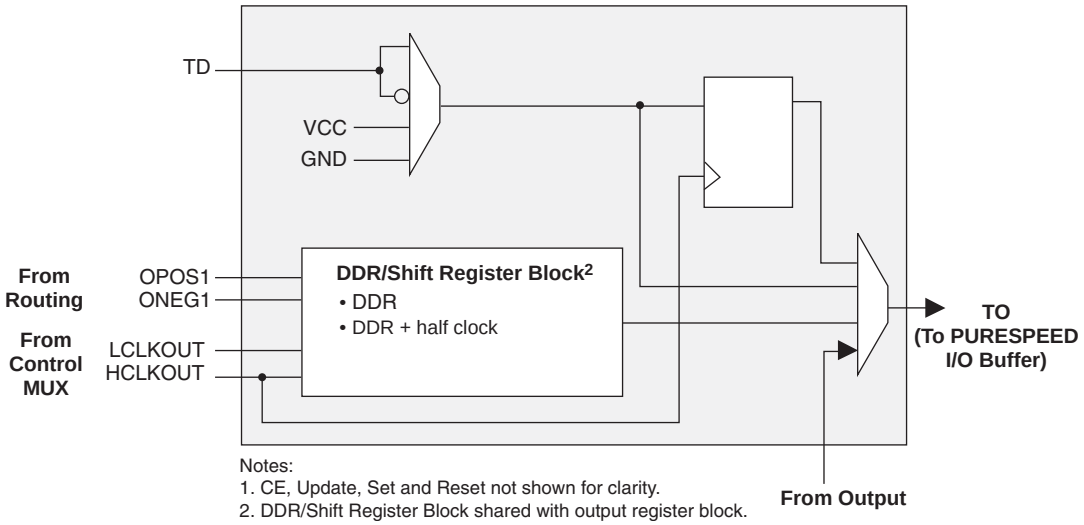
The SDR register operates on the positive edge of the high-speed clock. In it has a variety of programmable options for set/reset including, set or reset, asynchronous or synchronous Local Set Reset LSR and Global Set Reset GSR enable or disable. The register LSR input is driven from LSRO, which is generated from the PIO control MUX. The GSR input is driven from the GSR output of the PIO control MUX, which allows the global set-reset to be disabled on a PIO basis.

Tristate DDR/Shift Register Block

The DDR/Shift block is shared with the output block allowing DDR support using the high-speed clock and the associated transfer from the low-speed clock domain. It functions as a gearbox allowing low–speed parallel data from the FPGA fabric to provide a high-speed tri-state control stream.

There is a special mode for DDR-II memory interfaces where the termination is controlled by the output tristate signal. During WRITE cycle when the FPGA is driving the lines, the parallel terminations are turned off. During READ cycle when the FPGA is receiving data, the parallel terminations are turned on.

Figure 2-24. Tristate Register Block[1]



I/O Architecture Rules

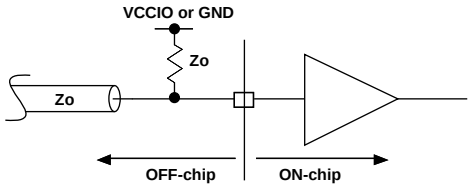
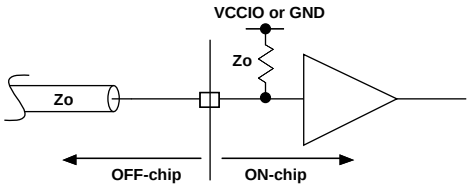
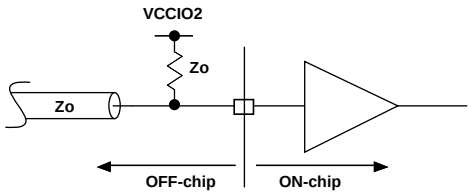
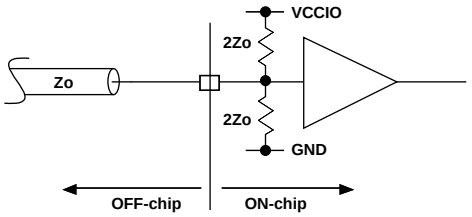
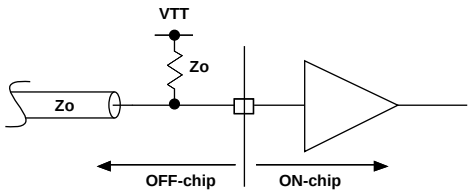
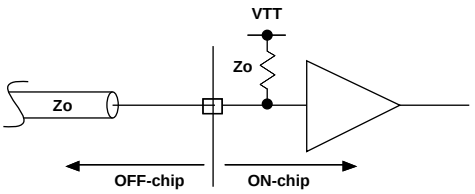
Table 2-6 shows the PIO usage for x1, x2, x4 gearing. The checkmarks in the columns show the specific PIOs that are used for each gearing mode. When using x2 or x4 gearing, any PIO which is not used for gearing can still be used as an output.

Single Ended Inputs: The SC devices support a number of different termination schemes for single ended inputs:

- Parallel to V_{CCIO} or GND
- Parallel to $V_{CCIO}/2$
- Parallel to V_{TT}

Figure 2-28 shows the single ended input schemes that are supported. The nominal values of the termination resistors are shown in Table 2-9.

Figure 2-28. Input Termination Schemes

Termination Type	Discrete Off-Chip Solution	Lattice On-Chip Solution
Parallel termination to to V_{CCIO}, or parallel to GND receiving end		
Parallel termination to $V_{CCIO}/2$ receiving end		
Parallel termination to V_{TT} at receiving end		

In many situations designers can chose whether to use Thevenin or parallel to V_{TT} termination. The Thevenin approach has the benefit of not requiring a termination voltage to be applied to the device. The parallel to V_{TT} approach consumes less power.

VTT Termination Resources

Each I/O bank, except bank 1, has a number of V_{TT} pins that must be connected if V_{TT} is used. Note V_{TT} pins can sink or source current and the power supply they are connected to must be able to handle the relatively high currents associated with the termination circuits. Note: V_{TT} is not available in all package styles.

On-chip parallel termination to V_{TT} is supported at the receiving end only. On-chip parallel output termination to V_{TT} is not supported.

The V_{TT} internal bus is also connected to the internal V_{CMT} node. Thus in one bank designers can implement either V_{TT} termination or V_{CMT} termination for differential inputs.

DDRII/RLDRAMII Termination Support

The DDR II memory and RLDRAMII (in Bidirection Data mode) standards require that the on-chip termination to V_{TT} be turned on when a pin is an input and off when the pin is an output. The LatticeSC devices contain the required circuitry to support this behavior. For additional detail refer to technical information at the end of the data sheet.

Power Supply Ramp Rates

Symbol	Parameter	Condition	Min.	Typ.	Max	Units
t_{RAMP}	Power supply ramp rates for all power supplies	Over process, voltage, temperature	3.45	—	—	mV/µs
			—	—	75	ms

1. See the Power-up and Power-Down requirements section for more details on power sequencing.
2. From 0.5V to minimum operating voltage.

Hot Socketing Specifications[1]

Symbol	Parameter	Condition	Min.	Typ.	Max	Units
I_{DK}	Programmable and dedicated Input or I/O leakage current[2, 3, 4, 5, 6]	0 <= V_{IN} <= V_{IH} (MAX)	—	—	±1500	µA
I_{HDIN}	SERDES average input current when device powered down and inputs driven[7]		—	—	4	mA

1. See Hot Socket power up/down information in Chapter 2 of this document.
2. Assumes monotonic rise/fall rates for all power supplies.
3. Sensitive to power supply sequencing as described in hot socketing section.
4. Assumes power supplies are between 0 and maximum recommended operations conditions.
5. IDK is additive to I_{PU}, I_{PD} or I_{BH}.
6. Represents DC conditions. For the first 20ns after hot insertion, current specification is 8 mA.
7. Assumes that the device is powered down with all supplies grounded, both P and N inputs driven by a CML driver with maximum allowed VDDOB of 1.575V, 8b/10b data and internal AC coupling.

DC Electrical Characteristics[5]

Over Recommended Operating Conditions

Symbol	Parameter	Condition	Min.[3]	Typ.	Max.	Units
I_{IL}, I_{IH}[1]	Input or I/O Low leakage	0 ≤ V_{IN} ≤ V_{IH} (MAX)	—	—	10	µA
I_{PU}	I/O Active Pull-up Current	0 ≤ V_{IN} ≤ 0.7 V_{CCIO}	-30	—	-210	µA
I_{PD}	I/O Active Pull-down Current	V_{IL} (MAX) ≤ V_{IN} ≤ V_{IH} (MAX)	30	—	210	µA
I_{BHLS}	Bus Hold Low Sustaining Current	V_{IN} = V_{IL} (MAX)	30	—	—	µA
I_{BHHS}	Bus Hold High Sustaining Current	V_{IN} = 0.7V_{CCIO}	-30	—	—	µA
I_{BHLO}	Bus Hold Low Overdrive Current	0 ≤ V_{IN} ≤ V_{IH} (MAX)	—	—	210	µA
I_{BHLH}	Bus Hold High Overdrive Current	0 ≤ V_{IN} ≤ V_{IH} (MAX)	—	—	-210	µA
I_{CL}	PCI Low Clamp Current	-3 < V_{IN} ≤ -1	-25 + (V_{IN} + 1)/0.015	—	—	mA
I_{CH}	PCI High Clamp Current	V_{CC} + 4 > V_{IN} ≥ V_{CC} + 1	25 + (V_{IN} - V_{CC} -1)/ 0.015	—	—	mA
V_{BHT}	Bus Hold trip Points	0 ≤ V_{IN} ≤ V_{IH} (MAX)	V_{IL} (MAX)	—	V_{IH} (MIN)	V
C1	I/O Capacitance[2]	V_{CCIO} = 3.3V, 2.5V, 1.8V, 1.5V, 1.2V, V_{CC} = 1.2V, V_{CCIP2} = 1.2V, V_{CCAUX} = 2.5, V_{IO} = 0 to V_{IH} (MAX)	—	8	—	pf
C3[2]	Dedicated Input Capacitance[2]	V_{CCIO} = 3.3V, 2.5V, 1.8V, 1.5V, 1.2V, V_{CC} = 1.2V, V_{CCIP2} = 1.2V, V_{CCAUX} = 2.5, V_{IO} = 0 to V_{IH} (MAX)	—	6	—	pf

1. Input or I/O leakage current is measured with the pin configured as an input or as an I/O with the output driver tri-stated. It is not measured with the output driver active. Bus maintenance circuits are disabled.
2. T_A 25°C, f = 1.0MHz
3. I_{PU}, I_{PD}, I_{BHLS} and I_{BHHS} have minimum values of 15 or -15µA if V_{CCIO} is set to 1.2V nominal.
4. This table does not apply to SERDES pins.
5. For programmable I/Os.

LFSC/M15 Logic Signal Connections: 256 fpBGA[1,2] (Cont.)

Ball Number	LFSC/M15		
	Ball Function	VCCIO Bank	Dual Function
N12	PB39C	4	
T15	PB40A	4	PCLKT4_3
R16	PB40B	4	PCLKC4_3
L12	PB43A	4	
M12	PB43B	4	
P16	PB44A	4	
N16	PB44B	4	
R14	PB47C	4	VREF1_4
P15	PB48A	4	LRC_DLLT_IN_C/LRC_DLLT_FB_D
M13	PB48B	4	LRC_DLLC_IN_C/LRC_DLLC_FB_D
N13	PB49A	4	LRC_PLLT_IN_A/LRC_PLLT_FB_B
P14	PB49B	4	LRC_PLLC_IN_A/LRC_PLLC_FB_B
M16	PR45B	3	LRC_DLLC_IN_F/LRC_DLLC_FB_E
L16	PR45A	3	LRC_DLLT_IN_F/LRC_DLLT_FB_E
M14	PR43B	3	
M15	PR43A	3	
K16	PR41D	3	VREF2_3
J16	PR37B	3	
H16	PR37A	3	
L13	PR35D	3	DIFFR_3
L14	PR35B	3	
L15	PR35A	3	
K12	PR31C	3	VREF1_3
J13	PR28D	3	PCLKC3_2
K13	PR28C	3	PCLKT3_2
H15	PR28B	3	
F16	PR28A	3	
J11	PR26D	3	PCLKC3_1
J12	PR26C	3	PCLKT3_1
J15	PR26B	3	PCLKC3_0
J14	PR26A	3	PCLKT3_0
E16	PR24D	2	PCLKC2_2
D16	PR24C	2	PCLKT2_2
H11	PR24B	2	PCLKC2_0
H12	PR24A	2	PCLKT2_0
H13	PR23B	2	PCLKC2_1
H14	PR23A	2	PCLKT2_1
G12	PR22D	2	DIFFR_2
G13	PR22C	2	VREF1_2
F8	PR22B	2	
F9	PR22A	2	
G16	PR18D	2	VREF2_2
F15	PR17B	2	URC_DLLC_IN_C/URC_DLLC_FB_D

LFSC/M15, LFSC/M25 Logic Signal Connections: 900 fpBGA[1, 2] (Cont.)

Ball Number	LFSC/M15			LFSC/M25		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
A29	RESP_URC	-		RESP_URC	-	
D26	VCC12	-		VCC12	-	
C30	A_REFCLKN_R	-		A_REFCLKN_R	-	
B30	A_REFCLKP_R	-		A_REFCLKP_R	-	
F24	A_VDDAX25_R	-		A_VDDAX25_R	-	
D25	VCC12	-		VCC12	-	
C28	A_VDDIB0_R	-		A_VDDIB0_R	-	
B28	A_HDINP0_R	-	PCS 3E0 CH 0 IN P	A_HDINP0_R	-	PCS 3E0 CH 0 IN P
B27	A_HDINN0_R	-	PCS 3E0 CH 0 IN N	A_HDINN0_R	-	PCS 3E0 CH 0 IN N
E25	VCC12	-		VCC12	-	
A28	A_HDOUTP0_R	-	PCS 3E0 CH 0 OUT P	A_HDOUTP0_R	-	PCS 3E0 CH 0 OUT P
C27	A_VDDOB0_R	-		A_VDDOB0_R	-	
A27	A_HDOUTN0_R	-	PCS 3E0 CH 0 OUT N	A_HDOUTN0_R	-	PCS 3E0 CH 0 OUT N
C26	A_VDDOB1_R	-		A_VDDOB1_R	-	
A26	A_HDOUTN1_R	-	PCS 3E0 CH 1 OUT N	A_HDOUTN1_R	-	PCS 3E0 CH 1 OUT N
D24	VCC12	-		VCC12	-	
A25	A_HDOUTP1_R	-	PCS 3E0 CH 1 OUT P	A_HDOUTP1_R	-	PCS 3E0 CH 1 OUT P
B26	A_HDINN1_R	-	PCS 3E0 CH 1 IN N	A_HDINN1_R	-	PCS 3E0 CH 1 IN N
B25	A_HDINP1_R	-	PCS 3E0 CH 1 IN P	A_HDINP1_R	-	PCS 3E0 CH 1 IN P
E24	VCC12	-		VCC12	-	
C25	A_VDDIB1_R	-		A_VDDIB1_R	-	
D23	VCC12	-		VCC12	-	
C24	A_VDDIB2_R	-		A_VDDIB2_R	-	
B24	A_HDINP2_R	-	PCS 3E0 CH 2 IN P	A_HDINP2_R	-	PCS 3E0 CH 2 IN P
B23	A_HDINN2_R	-	PCS 3E0 CH 2 IN N	A_HDINN2_R	-	PCS 3E0 CH 2 IN N
E23	VCC12	-		VCC12	-	
A24	A_HDOUTP2_R	-	PCS 3E0 CH 2 OUT P	A_HDOUTP2_R	-	PCS 3E0 CH 2 OUT P
C23	A_VDDOB2_R	-		A_VDDOB2_R	-	
A23	A_HDOUTN2_R	-	PCS 3E0 CH 2 OUT N	A_HDOUTN2_R	-	PCS 3E0 CH 2 OUT N
C22	A_VDDOB3_R	-		A_VDDOB3_R	-	
A22	A_HDOUTN3_R	-	PCS 3E0 CH 3 OUT N	A_HDOUTN3_R	-	PCS 3E0 CH 3 OUT N
D22	VCC12	-		VCC12	-	
A21	A_HDOUTP3_R	-	PCS 3E0 CH 3 OUT P	A_HDOUTP3_R	-	PCS 3E0 CH 3 OUT P
B22	A_HDINN3_R	-	PCS 3E0 CH 3 IN N	A_HDINN3_R	-	PCS 3E0 CH 3 IN N
B21	A_HDINP3_R	-	PCS 3E0 CH 3 IN P	A_HDINP3_R	-	PCS 3E0 CH 3 IN P
E22	VCC12	-		VCC12	-	
C21	A_VDDIB3_R	-		A_VDDIB3_R	-	
G22	PT43D	1	HDC/SI	PT49D	1	HDC/SI
F22	PT43C	1	LDCN/SCS	PT49C	1	LDCN/SCS
B20	PT41B	1	D8/MPI_DATA8	PT49B	1	D8/MPI_DATA8
B19	PT41A	1	CS1/MPI_CS1	PT49A	1	CS1/MPI_CS1
A20	PT40D	1	D9/MPI_DATA9	PT47D	1	D9/MPI_DATA9
A19	PT40C	1	D10/MPI_DATA10	PT47C	1	D10/MPI_DATA10
D19	PT39B	1	CS0N/MPI_CS0N	PT47B	1	CS0N/MPI_CS0N
D18	PT39A	1	RDN/MPI_STRB_N	PT47A	1	RDN/MPI_STRB_N

LFSC/M15, LFSC/M25 Logic Signal Connections: 900 fpBGA[1, 2] (Cont.)

Ball Number	LFSC/M15			LFSC/M25		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
Y9	VCCIO6	-		VCCIO6	-	
J7	VCCIO7	-		VCCIO7	-	
J8	VCCIO7	-		VCCIO7	-	
K7	VCCIO7	-		VCCIO7	-	
K8	VCCIO7	-		VCCIO7	-	
L8	VCCIO7	-		VCCIO7	-	
L9	VCCIO7	-		VCCIO7	-	
M9	VCCIO7	-		VCCIO7	-	
N9	VCCIO7	-		VCCIO7	-	
P9	VCCIO7	-		VCCIO7	-	
R9	VCCIO7	-		VCCIO7	-	
A1	GND	-		GND	-	
A30	GND	-		GND	-	
AA15	GND	-		GND	-	
AA16	GND	-		GND	-	
AK1	GND	-		GND	-	
AK30	GND	-		GND	-	
K15	GND	-		GND	-	
K16	GND	-		GND	-	
L11	GND	-		GND	-	
L12	GND	-		GND	-	
L13	GND	-		GND	-	
L14	GND	-		GND	-	
L15	GND	-		GND	-	
L16	GND	-		GND	-	
L17	GND	-		GND	-	
L18	GND	-		GND	-	
L19	GND	-		GND	-	
L20	GND	-		GND	-	
M11	GND	-		GND	-	
M12	GND	-		GND	-	
M13	GND	-		GND	-	
M14	GND	-		GND	-	
M15	GND	-		GND	-	
M16	GND	-		GND	-	
M17	GND	-		GND	-	
M18	GND	-		GND	-	
M19	GND	-		GND	-	
M20	GND	-		GND	-	
N11	GND	-		GND	-	
N12	GND	-		GND	-	
N13	GND	-		GND	-	
N14	GND	-		GND	-	
N15	GND	-		GND	-	
N16	GND	-		GND	-	

LFSC/M40, LFSC/M80 Logic Signal Connections: 1152 fcBGA[1, 2] (Cont.)

Ball Number	LFSC/M40			LFSC/M80		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
E24	B_HDINP1_L	-	PCS 361 CH 1 IN P	B_HDINP1_L	-	PCS 361 CH 1 IN P
F24	B_HDINN1_L	-	PCS 361 CH 1 IN N	B_HDINN1_L	-	PCS 361 CH 1 IN N
A23	B_HDOUTP1_L	-	PCS 361 CH 1 OUT P	B_HDOUTP1_L	-	PCS 361 CH 1 OUT P
L25	VCC12	-		VCC12	-	
B23	B_HDOUTN1_L	-	PCS 361 CH 1 OUT N	B_HDOUTN1_L	-	PCS 361 CH 1 OUT N
D24	B_VDDOB1_L	-		B_VDDOB1_L	-	
B24	B_HDOUTN0_L	-	PCS 361 CH 0 OUT N	B_HDOUTN0_L	-	PCS 361 CH 0 OUT N
D25	B_VDDOB0_L	-		B_VDDOB0_L	-	
A24	B_HDOUTP0_L	-	PCS 361 CH 0 OUT P	B_HDOUTP0_L	-	PCS 361 CH 0 OUT P
K25	VCC12	-		VCC12	-	
F25	B_HDINN0_L	-	PCS 361 CH 0 IN N	B_HDINN0_L	-	PCS 361 CH 0 IN N
E25	B_HDINP0_L	-	PCS 361 CH 0 IN P	B_HDINP0_L	-	PCS 361 CH 0 IN P
D28	B_VDDIB0_L	-		B_VDDIB0_L	-	
G25	VCC12	-		VCC12	-	
D29	A_VDDIB3_L	-		A_VDDIB3_L	-	
C25	VCC12	-		VCC12	-	
A25	A_HDINP3_L	-	PCS 360 CH 3 IN P	A_HDINP3_L	-	PCS 360 CH 3 IN P
B25	A_HDINN3_L	-	PCS 360 CH 3 IN N	A_HDINN3_L	-	PCS 360 CH 3 IN N
A26	A_HDOUTP3_L	-	PCS 360 CH 3 OUT P	A_HDOUTP3_L	-	PCS 360 CH 3 OUT P
E27	VCC12	-		VCC12	-	
B26	A_HDOUTN3_L	-	PCS 360 CH 3 OUT N	A_HDOUTN3_L	-	PCS 360 CH 3 OUT N
F26	A_VDDOB3_L	-		A_VDDOB3_L	-	
B27	A_HDOUTN2_L	-	PCS 360 CH 2 OUT N	A_HDOUTN2_L	-	PCS 360 CH 2 OUT N
F27	A_VDDOB2_L	-		A_VDDOB2_L	-	
A27	A_HDOUTP2_L	-	PCS 360 CH 2 OUT P	A_HDOUTP2_L	-	PCS 360 CH 2 OUT P
E28	VCC12	-		VCC12	-	
B28	A_HDINN2_L	-	PCS 360 CH 2 IN N	A_HDINN2_L	-	PCS 360 CH 2 IN N
A28	A_HDINP2_L	-	PCS 360 CH 2 IN P	A_HDINP2_L	-	PCS 360 CH 2 IN P
D30	A_VDDIB2_L	-		A_VDDIB2_L	-	
C28	VCC12	-		VCC12	-	
D31	A_VDDIB1_L	-		A_VDDIB1_L	-	
C29	VCC12	-		VCC12	-	
A29	A_HDINP1_L	-	PCS 360 CH 1 IN P	A_HDINP1_L	-	PCS 360 CH 1 IN P
B29	A_HDINN1_L	-	PCS 360 CH 1 IN N	A_HDINN1_L	-	PCS 360 CH 1 IN N
A30	A_HDOUTP1_L	-	PCS 360 CH 1 OUT P	A_HDOUTP1_L	-	PCS 360 CH 1 OUT P
E29	VCC12	-		VCC12	-	
B30	A_HDOUTN1_L	-	PCS 360 CH 1 OUT N	A_HDOUTN1_L	-	PCS 360 CH 1 OUT N
F28	A_VDDOB1_L	-		A_VDDOB1_L	-	
B31	A_HDOUTN0_L	-	PCS 360 CH 0 OUT N	A_HDOUTN0_L	-	PCS 360 CH 0 OUT N
F29	A_VDDOB0_L	-		A_VDDOB0_L	-	
A31	A_HDOUTP0_L	-	PCS 360 CH 0 OUT P	A_HDOUTP0_L	-	PCS 360 CH 0 OUT P
E30	VCC12	-		VCC12	-	
B32	A_HDINN0_L	-	PCS 360 CH 0 IN N	A_HDINN0_L	-	PCS 360 CH 0 IN N
A32	A_HDINP0_L	-	PCS 360 CH 0 IN P	A_HDINP0_L	-	PCS 360 CH 0 IN P
D32	A_VDDIB0_L	-		A_VDDIB0_L	-	

LFSC/M115 Logic Signal Connections: 1152 fcBGA[1, 2]

Ball Number	LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function
AJ34	PL98A	6	
AK34	PL98B	6	
AB27	PL98C	6	
AC27	PL98D	6	
AF33	PL99A	6	
AG33	PL99B	6	
AC29	PL99C	6	
AD29	PL99D	6	
AE31	PL103A	6	
AF31	PL103B	6	
AF30	PL103C	6	
AF29	PL103D	6	
AH33	PL104A	6	
AJ33	PL104B	6	
AC28	PL104C	6	
AD28	PL104D	6	
AH32	PL107A	6	
AJ32	PL107B	6	
AD27	PL107C	6	
AE27	PL107D	6	VREF2_6
AG34	PL109A	6	
AH34	PL109B	6	
AC26	PL109C	6	
AB26	PL109D	6	
AK33	PL112A	6	
AL33	PL112B	6	
AG30	PL112C	6	
AH30	PL112D	6	
AL34	PL115A	6	
AM34	PL115B	6	
AJ30	PL115C	6	LLC_DLLT_IN_E/LLC_DLLT_FB_F
AK30	PL115D	6	LLC_DLLC_IN_E/LLC_DLLC_FB_F
AJ31	PL116A	6	
AH31	PL116B	6	
AD26	PL116C	6	
AD25	PL116D	6	
AL32	PL117A	6	LLC_DLLT_IN_F/LLC_DLLT_FB_E
AL31	PL117B	6	LLC_DLLC_IN_F/LLC_DLLC_FB_E
AG29	PL117C	6	LLC_PLLT_IN_B/LLC_PLLT_FB_A
AG28	PL117D	6	LLC_PLLC_IN_B/LLC_PLLC_FB_A
AF28	XRES	-	
AF27	TEMP	6	
AM33	PB3A	5	LLC_PLLT_IN_A/LLC_PLLT_FB_B

LFSC/M115 Logic Signal Connections: 1152 fcBGA[1, 2]

Ball Number	LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function
J17	PT81C	1	D20/PCLKT1_2/MPI_DATA20
D16	PT81B	1	MCA_CLK_P1_OUT
E16	PT81A	1	MCA_CLK_P1_IN
H15	PT78D	1	D21/PCLKC1_1/MPI_DATA21
H16	PT78C	1	D22/PCLKT1_1/MPI_DATA22
C15	PT78B	1	MCA_CLK_P2_OUT
C16	PT78A	1	MCA_CLK_P2_IN
L17	PT75D	1	MCA_DONE_OUT
K17	PT75C	1	BUSYN/RCLK/SCK
E17	PT75B	1	DP0/MPI_PAR0
F17	PT75A	1	MPI_TA
G17	PT73D	1	D23/MPI_DATA23
H17	PT73C	1	DP2/MPI_PAR2
A17	PT73B	1	PCLKC1_0
B17	PT73A	1	PCLKT1_0/MPI_CLK
G18	PT71D	1	DP3/PCLKC1_4/MPI_PAR3
H18	PT71C	1	D24/PCLKT1_4/MPI_DATA24
E18	PT71B	1	MPI_RETRY
F18	PT71A	1	A0/MPI_ADDR14
J18	PT69D	1	A1/MPI_ADDR15
J19	PT69C	1	A2/MPI_ADDR16
C20	PT69B	1	A3/MPI_ADDR17
C19	PT69A	1	A4/MPI_ADDR18
K18	PT66D	1	D25/PCLKC1_5/MPI_DATA25
L18	PT66C	1	D26/PCLKT1_5/MPI_DATA26
D19	PT66B	1	A5/MPI_ADDR19
E19	PT66A	1	A6/MPI_ADDR20
H19	PT63D	1	D27/MPI_DATA27
H20	PT63C	1	VREF1_1
A18	PT63B	1	A7/MPI_ADDR21
B18	PT63A	1	A8/MPI_ADDR22
H21	PT61D	1	D28/PCLKC1_6/MPI_DATA28
J21	PT61C	1	D29/PCLKT1_6/MPI_DATA29
A19	PT61B	1	A9/MPI_ADDR23
B19	PT61A	1	A10/MPI_ADDR24
H22	PT58D	1	D30/PCLKC1_7/MPI_DATA30
J22	PT58C	1	D31/PCLKT1_7/MPI_DATA31
F20	PT58B	1	A11/MPI_ADDR25
G20	PT58A	1	A12/MPI_ADDR26
K21	PT57D	1	D11/MPI_DATA11
K22	PT57C	1	D12/MPI_DATA12
A20	PT57B	1	A13/MPI_ADDR27
B20	PT57A	1	A14/MPI_ADDR28

LFSC/M115 Logic Signal Connections: 1152 fcBGA[1, 2]

Ball Number	LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function
K26	GND	-	
K28	GND	-	
K6	GND	-	
K9	GND	-	
L12	GND	-	
L32	GND	-	
L4	GND	-	
M10	GND	-	
M17	GND	-	
M24	GND	-	
N29	GND	-	
N7	GND	-	
P15	GND	-	
P20	GND	-	
P3	GND	-	
P31	GND	-	
R10	GND	-	
R14	GND	-	
R16	GND	-	
R19	GND	-	
R21	GND	-	
R26	GND	-	
T15	GND	-	
T17	GND	-	
T18	GND	-	
T20	GND	-	
T28	GND	-	
T6	GND	-	
U16	GND	-	
U19	GND	-	
U23	GND	-	
U32	GND	-	
U4	GND	-	
V12	GND	-	
V16	GND	-	
V19	GND	-	
V3	GND	-	
V31	GND	-	
W15	GND	-	
W17	GND	-	
W18	GND	-	
W20	GND	-	
W29	GND	-	

LFSC/M115 Logic Signal Connections: 1152 fcBGA[1, 2]

Ball Number	LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function
AH16	VCCIO4	-	
AJ13	VCCIO4	-	
AJ7	VCCIO4	-	
AL14	VCCIO4	-	
AL8	VCCIO4	-	
AM11	VCCIO4	-	
AM17	VCCIO4	-	
AM5	VCCIO4	-	
AE20	VCCIO5	-	
AE23	VCCIO5	-	
AE26	VCCIO5	-	
AH22	VCCIO5	-	
AH28	VCCIO5	-	
AJ19	VCCIO5	-	
AJ25	VCCIO5	-	
AL18	VCCIO5	-	
AL24	VCCIO5	-	
AL30	VCCIO5	-	
AM21	VCCIO5	-	
AM27	VCCIO5	-	
AA31	VCCIO6	-	
AB29	VCCIO6	-	
AC24	VCCIO6	-	
AD32	VCCIO6	-	
AE28	VCCIO6	-	
AG31	VCCIO6	-	
AK32	VCCIO6	-	
T29	VCCIO6	-	
U31	VCCIO6	-	
V32	VCCIO6	-	
W28	VCCIO6	-	
Y26	VCCIO6	-	
E31	VCCIO7	-	
G28	VCCIO7	-	
H32	VCCIO7	-	
K29	VCCIO7	-	
L31	VCCIO7	-	
M25	VCCIO7	-	
N28	VCCIO7	-	
P32	VCCIO7	-	
R25	VCCIO7	-	
J25	VCCIO1	-	
N11	VTT_2	2	

LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA[1, 2] (Cont.)

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AP1	PR90B	3		PR109B	3	
AN1	PR90A	3		PR109A	3	
AK10	PR89D	3	VREF2_3	PR107D	3	VREF2_3
AJ10	PR89C	3		PR107C	3	
AM5	PR89B	3		PR107B	3	
AL5	PR89A	3		PR107A	3	
AL7	PR86D	3		PR104D	3	
AK7	PR86C	3		PR104C	3	
AM1	PR86B	3		PR104B	3	
AL1	PR86A	3		PR104A	3	
AJ11	PR85D	3		PR103D	3	
AH11	PR85C	3		PR103C	3	
AK5	PR85B	3		PR103B	3	
AJ5	PR85A	3		PR103A	3	
AK9	PR84D	3		PR99D	3	
AJ9	PR84C	3		PR99C	3	
AK3	PR84B	3		PR99B	3	
AJ3	PR84A	3		PR99A	3	
AK6	PR82D	3		PR98D	3	
AJ6	PR82C	3		PR98C	3	
AK2	PR82B	3		PR98B	3	
AJ2	PR82A	3		PR98A	3	
AH10	PR81D	3		PR96D	3	
AG10	PR81C	3		PR96C	3	
AK1	PR81B	3		PR96B	3	
AJ1	PR81A	3		PR96A	3	
AH9	PR80D	3		PR94D	3	
AG9	PR80C	3		PR94C	3	
AH2	PR80B	3		PR94B	3	
AG2	PR80A	3		PR94A	3	
AH8	PR78D	3		PR92D	3	
AG8	PR78C	3		PR92C	3	
AG1	PR78B	3		PR92B	3	
AH1	PR78A	3		PR92A	3	
AG14	PR77D	3		PR91D	3	
AF14	PR77C	3		PR91C	3	
AG4	PR77B	3		PR91B	3	
AF4	PR77A	3		PR91A	3	
AH7	PR76D	3	DIFFR_3	PR90D	3	DIFFR_3
AG7	PR76C	3		PR90C	3	
AG3	PR76B	3		PR90B	3	
AF3	PR76A	3		PR90A	3	
AH6	PR74D	3		PR88D	3	
AG6	PR74C	3		PR88C	3	
AF1	PR74B	3		PR88B	3	

LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA[1, 2] (Cont.)

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AM27	GND	-		GND	-	
AM36	GND	-		GND	-	
AM7	GND	-		GND	-	
AP4	GND	-		GND	-	
AP40	GND	-		GND	-	
AR14	GND	-		GND	-	
AR20	GND	-		GND	-	
AR23	GND	-		GND	-	
AR29	GND	-		GND	-	
AR35	GND	-		GND	-	
AR8	GND	-		GND	-	
AT11	GND	-		GND	-	
AT17	GND	-		GND	-	
AT26	GND	-		GND	-	
AT32	GND	-		GND	-	
AU3	GND	-		GND	-	
AU39	GND	-		GND	-	
AW12	GND	-		GND	-	
AW18	GND	-		GND	-	
AW22	GND	-		GND	-	
AW28	GND	-		GND	-	
AW34	GND	-		GND	-	
AW6	GND	-		GND	-	
AY15	GND	-		GND	-	
AY21	GND	-		GND	-	
AY25	GND	-		GND	-	
AY31	GND	-		GND	-	
AY37	GND	-		GND	-	
AY9	GND	-		GND	-	
B1	GND	-		GND	-	
B42	GND	-		GND	-	
BA1	GND	-		GND	-	
BA42	GND	-		GND	-	
BB2	GND	-		GND	-	
BB41	GND	-		GND	-	
C10	GND	-		GND	-	
C12	GND	-		GND	-	
C13	GND	-		GND	-	
C16	GND	-		GND	-	
C18	GND	-		GND	-	
C19	GND	-		GND	-	
C22	GND	-		GND	-	
C24	GND	-		GND	-	
C27	GND	-		GND	-	
C28	GND	-		GND	-	

LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA[1, 2] (Cont.)

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AH27	VCCAUX	-		VCCAUX	-	
AH29	VCCAUX	-		VCCAUX	-	
AJ14	VCCAUX	-		VCCAUX	-	
AJ15	VCCAUX	-		VCCAUX	-	
AJ28	VCCAUX	-		VCCAUX	-	
AJ29	VCCAUX	-		VCCAUX	-	
P14	VCCAUX	-		VCCAUX	-	
P15	VCCAUX	-		VCCAUX	-	
P28	VCCAUX	-		VCCAUX	-	
P29	VCCAUX	-		VCCAUX	-	
R14	VCCAUX	-		VCCAUX	-	
R16	VCCAUX	-		VCCAUX	-	
R17	VCCAUX	-		VCCAUX	-	
R18	VCCAUX	-		VCCAUX	-	
R19	VCCAUX	-		VCCAUX	-	
R20	VCCAUX	-		VCCAUX	-	
R23	VCCAUX	-		VCCAUX	-	
R24	VCCAUX	-		VCCAUX	-	
R25	VCCAUX	-		VCCAUX	-	
R26	VCCAUX	-		VCCAUX	-	
R27	VCCAUX	-		VCCAUX	-	
R29	VCCAUX	-		VCCAUX	-	
T15	VCCAUX	-		VCCAUX	-	
T28	VCCAUX	-		VCCAUX	-	
U15	VCCAUX	-		VCCAUX	-	
U28	VCCAUX	-		VCCAUX	-	
V15	VCCAUX	-		VCCAUX	-	
V28	VCCAUX	-		VCCAUX	-	
W15	VCCAUX	-		VCCAUX	-	
W28	VCCAUX	-		VCCAUX	-	
Y15	VCCAUX	-		VCCAUX	-	
Y28	VCCAUX	-		VCCAUX	-	
F3	VCCIO1	-		VCCIO1	-	
F39	VCCIO1	-		VCCIO1	-	
G35	VCCIO1	-		VCCIO1	-	
G8	VCCIO1	-		VCCIO1	-	
L19	VCCIO1	-		VCCIO1	-	
L24	VCCIO1	-		VCCIO1	-	
M16	VCCIO1	-		VCCIO1	-	
M27	VCCIO1	-		VCCIO1	-	
N11	VCCIO1	-		VCCIO1	-	
N32	VCCIO1	-		VCCIO1	-	
AA4	VCCIO2	-		VCCIO2	-	
H7	VCCIO2	-		VCCIO2	-	
J4	VCCIO2	-		VCCIO2	-	

LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA[1, 2] (Cont.)

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AW25	VCCIO5	-		VCCIO5	-	
AW31	VCCIO5	-		VCCIO5	-	
AW37	VCCIO5	-		VCCIO5	-	
AY22	VCCIO5	-		VCCIO5	-	
AY28	VCCIO5	-		VCCIO5	-	
AY34	VCCIO5	-		VCCIO5	-	
AB39	VCCIO6	-		VCCIO6	-	
AC36	VCCIO6	-		VCCIO6	-	
AD32	VCCIO6	-		VCCIO6	-	
AE40	VCCIO6	-		VCCIO6	-	
AF35	VCCIO6	-		VCCIO6	-	
AG31	VCCIO6	-		VCCIO6	-	
AH39	VCCIO6	-		VCCIO6	-	
AJ36	VCCIO6	-		VCCIO6	-	
AK32	VCCIO6	-		VCCIO6	-	
AL40	VCCIO6	-		VCCIO6	-	
AM35	VCCIO6	-		VCCIO6	-	
AP39	VCCIO6	-		VCCIO6	-	
AR36	VCCIO6	-		VCCIO6	-	
AU40	VCCIO6	-		VCCIO6	-	
AA40	VCCIO7	-		VCCIO7	-	
H36	VCCIO7	-		VCCIO7	-	
J40	VCCIO7	-		VCCIO7	-	
L35	VCCIO7	-		VCCIO7	-	
M39	VCCIO7	-		VCCIO7	-	
P36	VCCIO7	-		VCCIO7	-	
R40	VCCIO7	-		VCCIO7	-	
T31	VCCIO7	-		VCCIO7	-	
U35	VCCIO7	-		VCCIO7	-	
V39	VCCIO7	-		VCCIO7	-	
W32	VCCIO7	-		VCCIO7	-	
Y36	VCCIO7	-		VCCIO7	-	
AA14	VTT_2	2		VTT_2	2	
AA15	VTT_2	2		VTT_2	2	
R12	VTT_2	2		VTT_2	2	
V14	VTT_2	2		VTT_2	2	
AB14	VTT_3	3		VTT_3	3	
AB15	VTT_3	3		VTT_3	3	
AE14	VTT_3	3		VTT_3	3	
AJ13	VTT_3	3		VTT_3	3	
AH21	VTT_4	4		VTT_4	4	
AJ18	VTT_4	4		VTT_4	4	
AJ19	VTT_4	4		VTT_4	4	
AJ20	VTT_4	4		VTT_4	4	
AJ21	VTT_4	4		VTT_4	4	

Industrial, Cont.

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSCM3GA40EP1-6FFN1020I[1]	-6	Lead-Free Organic fcBGA	1020	IND	40.4
LFSCM3GA40EP1-5FFN1020I[1]	-5	Lead-Free Organic fcBGA	1020	IND	40.4
LFSCM3GA40EP1-6FFAN1020I	-6	Lead-Free Organic fcBGA Revision 2	1020	IND	40.4
LFSCM3GA40EP1-5FFAN1020I	-5	Lead-Free Organic fcBGA Revision 2	1020	IND	40.4
LFSCM3GA40EP1-6FCN1152I[2]	-6	Lead-Free Ceramic fcBGA	1152	IND	40.4
LFSCM3GA40EP1-5FCN1152I[2]	-5	Lead-Free Ceramic fcBGA	1152	IND	40.4
LFSCM3GA40EP1-6FFN1152I	-6	Lead-Free Organic fcBGA	1152	IND	40.4
LFSCM3GA40EP1-5FFN1152I	-5	Lead-Free Organic fcBGA	1152	IND	40.4

1. Converted to organic flip-chip BGA package revision 2 per PCN #02A-10.
2. Converted to organic flip-chip BGA package per PCN #01A-10.

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSC3GA80E-6FCN1152I[1]	-6	Lead-Free Ceramic fcBGA	1152	IND	80.1
LFSC3GA80E-5FCN1152I[1]	-5	Lead-Free Ceramic fcBGA	1152	IND	80.1
LFSC3GA80E-6FFN1152I	-6	Lead-Free Organic fcBGA	1152	IND	80.1
LFSC3GA80E-5FFN1152I	-5	Lead-Free Organic fcBGA	1152	IND	80.1
LFSC3GA80E-6FCN1704I[1]	-6	Lead-Free Ceramic fcBGA	1704	IND	80.1
LFSC3GA80E-5FCN1704I[1]	-5	Lead-Free Ceramic fcBGA	1704	IND	80.1
LFSC3GA80E-6FFN1704I	-6	Lead-Free Organic fcBGA	1704	IND	80.1
LFSC3GA80E-5FFN1704I	-5	Lead-Free Organic fcBGA	1704	IND	80.1

1. Converted to organic flip-chip BGA package per PCN #01A-10.

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSCM3GA80EP1-6FCN1152I[1]	-6	Lead-Free Ceramic fcBGA	1152	IND	80.1
LFSCM3GA80EP1-5FCN1152I[1]	-5	Lead-Free Ceramic fcBGA	1152	IND	80.1
LFSCM3GA80EP1-6FFN1152I	-6	Lead-Free Organic fcBGA	1152	IND	80.1
LFSCM3GA80EP1-5FFN1152I	-5	Lead-Free Organic fcBGA	1152	IND	80.1
LFSCM3GA80EP1-6FCN1704I[1]	-6	Lead-Free Ceramic fcBGA	1704	IND	80.1
LFSCM3GA80EP1-5FCN1704I[1]	-5	Lead-Free Ceramic fcBGA	1704	IND	80.1
LFSCM3GA80EP1-6FFN1704I	-6	Lead-Free Organic fcBGA	1704	IND	80.1
LFSCM3GA80EP1-5FFN1704I	-5	Lead-Free Organic fcBGA	1704	IND	80.1

1. Converted to organic flip-chip BGA package per PCN #01A-10.

LatticeSC/M Family Data Sheet Supplemental Information

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For Further Information

For further information about the flexiPCS, see the LatticeSC/M Family flexiPCS Data Sheet.

A variety of technical notes for the LatticeSC/M family are also available on the Lattice Semiconductor website at www.latticesemi.com.

- LatticeSC PURESPEED I/O Usage Guide (TN1088)
- LatticeSC PURESPEED I/O Adaptive Input Logic User's Guide (TN1158)
- LatticeSC sysCLOCK PLL/DLL User's Guide (TN1098)
- On-Chip Memory Usage Guide for LatticeSC Devices (TN1094)
- LatticeSC/M DDR/DDR2 SDRAM Memory Interface User's Guide (TN1099)
- LatticeSC QDRII/II+ SRAM Memory Interface User's Guide (TN1096)
- LatticeSC sysCONFIG Usage Guide (TN1080)
- LatticeSC MPI/System Bus (TN1085)
- SPI Serial Flash Programming Using ispJTAG in LatticeSC Devices (TN1100)
- Power Estimation and Management for LatticeSC Devices (TN1101)
- LatticeSC SERDES Jitter (TN1084)
- LatticeSC FPGAs: Implementing 3.3V Interfaces in 2.5V VCCIO Banks (TN1110)
- Lattice PCI Express Basic Demo User's Guide (UG08)
- LatticeSC flexiPCS/SERDES Design Guide (TN1145)
- Temperature Sensing Diode in LatticeSC Devices (TN1115)
- SPI4.2 Interoperability Between ORSPI4 and LatticeSC Devices (TN1116)

For further information on Interface standards refer to the following websites:

- JEDEC Standards (LVTTL, LVCMOS, SSTL, HSTL): www.jedec.org
- Optical Interface (SPI-4.2, XSBI, CSIX and XGMII): www.oiforum.com
- RAPIDIO: www.rapidio.org
- PCI/PCIX: ww.pcisig.com